

10/06/01
042330923THE COMMISSIONER OF PATENTS AND TRADEMARKS
Washington, D.C. 20231Our Ref: 1142-2/AMF
Date: April 5, 2001USPTO
JC986 09/827310
04/06/01PTO
Dear Sir:

Transmitted herewith for filing is the patent application of

Inventor(s): Harry Chan and Elio Moy
Title: PIPE EXTRUSION DIE FOR MULTI-LAYER PIPE

Enclosed are:

(X) Disclosure
(X) Claims
(X) Abstract
(X) Formal drawings (4 sheets)
(X) Declaration/Power of Attorney
() Assignment(s)
() Certified copy of the priority document(s)
() Cheque in the amount of \$ to be applied as follows:

Filing fee \$ 661.00

THE FILING FEE HAS BEEN CALCULATED AS SHOWN BELOW:

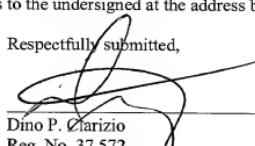
	No. Filed	No. Extra
Basic Fee		
Total Claims	54-20	34
Indep. Claims	3- 3	
Multiple dependent claims presented		

Small Entity		Large Entity	
RATE	FEE	OR	RATE
	\$355.00	OR	\$710.00
x 9=	\$306.00	OR	x 18= \$
x 40=	\$	OR	x 80= \$
+135=	\$	OR	+270= \$
TOTAL \$661.00		OR	TOTAL \$

(X) Applicant claims small entity status.

Please direct all correspondence and telephone inquiries to the undersigned at the address below.

Respectfully submitted,


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